



Product Summary

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	I_D
30V	7m Ω @10V	22A
	12m Ω @4.5V	

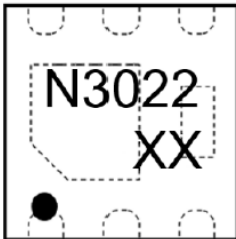
Feature

- Trench Technology Power MOSFET
- Low $R_{DS(ON)}$
- Low Gate Charge

Application

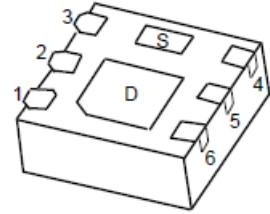
- Load Switch
- DC/DC Converter
- Power Management

MARKING:

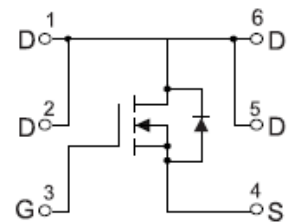


N3022 =Device Code
XX = Date Code

DFN2X2-6L



Schematic diagram



ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	30	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current ^{1,6}	I_D	$T_A = 25^\circ\text{C}$	22
		$T_A = 100^\circ\text{C}$	14
Pulsed Drain Current ²	I_{DM}	88	A
Single Pulsed Avalanche Current ³	I_{AS}	13	A
Single Pulsed Avalanche Energy ³	E_{AS}	42	mJ
Power Dissipation ^{5,6}	P_D	2.7	W
Thermal Resistance from Junction to Ambient ⁶	$R_{\theta JA}$	47	$^\circ\text{C/W}$
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-55~ +150	$^\circ\text{C}$

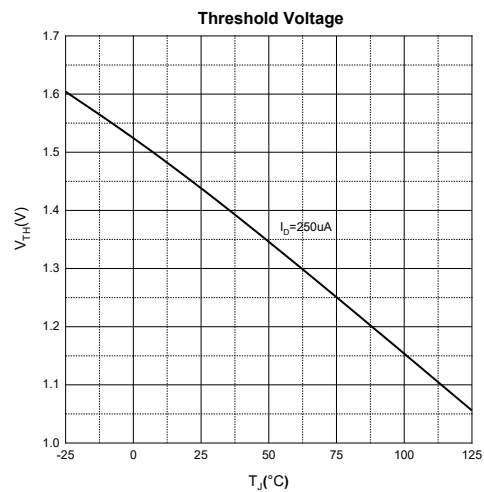
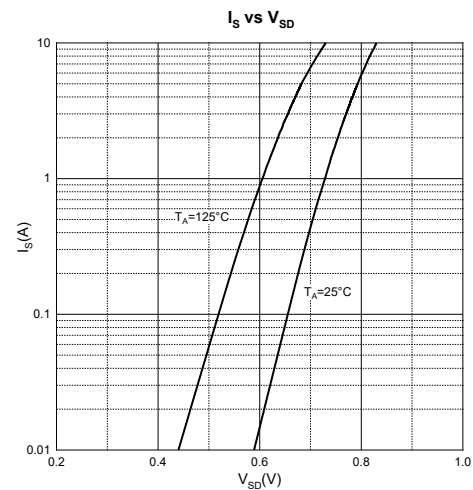
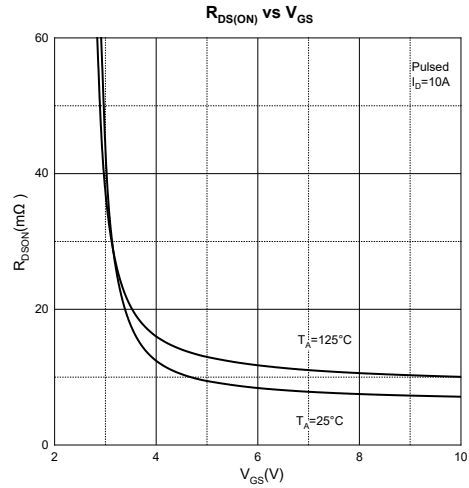
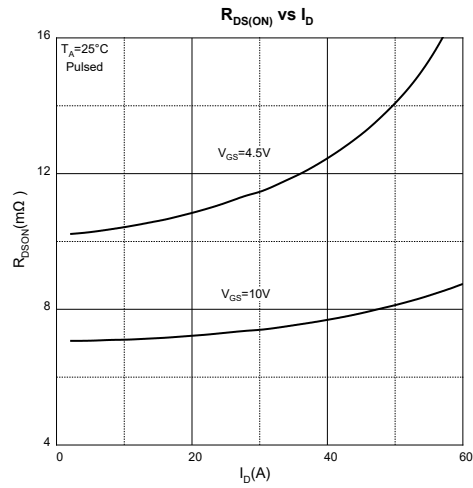
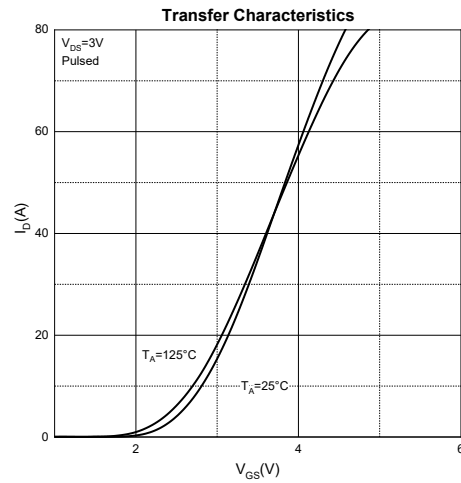
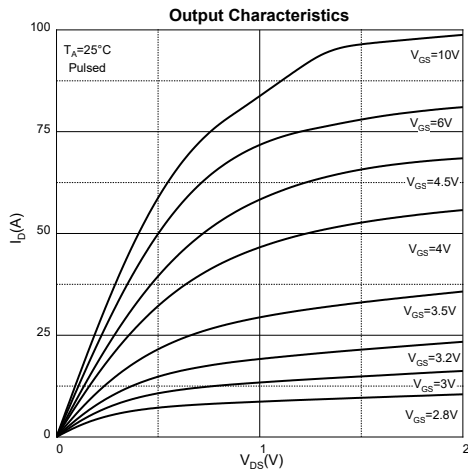
MOSFET ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

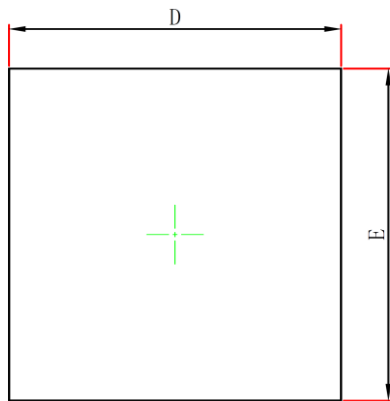
Parameter	Symbol	Test Condition	Min	Type	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 250μA	30			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 30V, V _{GS} = 0V			1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} = ±20V, V _{DS} = 0V			±100	nA
On Characteristics⁴						
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250μA	1	1.5	2	V
Drain-Source On-Resistance	R _{DS(on)}	V _{GS} = 10V, I _D = 10A		7	9	mΩ
		V _{GS} = 4.5V, I _D = 10A		12	18	
Dynamic Characteristics⁵						
Input Capacitance	C _{iss}	V _{DS} = 15V, V _{GS} = 0V, f = 1MHz		1307		pF
Output Capacitance	C _{oss}			152		
Reverse Transfer Capacitance	C _{rss}			136		
Gate Resistance	R _g	V _{DS} = 0V, V _{GS} = 0V, f = 1MHz		2.0		Ω
Switching Characteristics⁵						
Total Gate Charge	Q _g	V _{DS} = 20V, V _{GS} = 10V, I _D = 10A		28.6		nC
Gate-Source Charge	Q _{gs}			3.5		
Gate-Drain Charge	Q _{gd}			7.0		
Turn-On Delay Time	t _{d(on)}	V _{DD} = 10V, V _{GS} = 4.5V, R _G = 3Ω, R _L = 0.75Ω		10		ns
Turn-On Rise Time	t _r			14		
Turn-Off Delay Time	t _{d(off)}			33		
Turn-Off Fall Time	t _f			8		
Source-Drain Diode Characteristics						
Diode Forward Voltage ⁴	V _{SD}	V _{GS} = 0V, I _S = 10A			1.2	V

Notes :

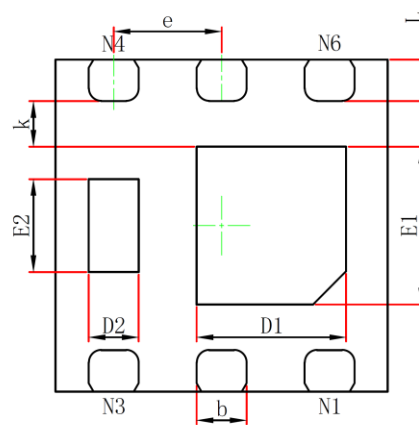
- 1.The maximum current rating is limited by package.
- 2.Pulse Test : Pulse Width ≤ 10μs, duty cycle ≤ 1%.
- 3.E_{AS} condition: V_{DD} = 15V, V_{GS} = 10V, L = 0.5mH, R_G = 25Ω, Starting T_J = 25°C.
- 4.Pulse Test : Pulse Width ≤ 300μs, duty cycle ≤ 2%.
- 5.The power dissipation P_D is limited by T_{J(MAX)} = 150°C.
- 6.Device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with T_A = 25°C.

Typical Characteristics

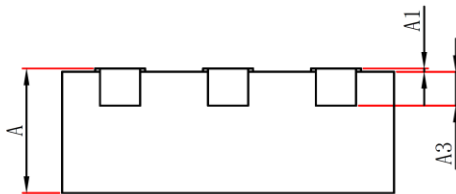


DFN2X2-6L Package Information


TOP VIEW



BOTTOM VIEW



SIDE VIEW

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.700	0.800	0.028	0.031
A1	0	0.050	0	0.002
A3	0.120	0.220	0.005	0.009
D	1.900	2.100	0.075	0.083
E	1.900	2.100	0.075	0.083
D1	0.800	1.050	0.031	0.041
E1	0.800	1.050	0.031	0.041
D2	0.200	0.400	0.008	0.016
E2	0.450	0.850	0.018	0.033
k	0.200MIN		0.008MIN	
b	0.250	0.350	0.010	0.014
e	0.65BSC		0.026TYP	
L	0.174	0.326	0.007	0.013

Attention:

- GreenPower Electronics reserves the right to improve product design function and reliability without notice.
- Any and all semiconductor products have certain probability to fail or malfunction, which may result in personal injury, death or property damage. Customer are solely responsible for providing adequate safe measures when design their systems.
- GreenPower Electronics products belong to consumer electronics or other civilian electronic products.